

Features :

- Trench+ Field Stop technology
- Low switching losses
- $V_{CE(sat)}$ with positive temperature coefficient
- Short circuit ruggedness

Typical Applications :

- Motor/ Servo Drives
- Wind Turbines Converters
- PV Inverters
- Energy Storage Converters
- UPS

1 IGBT, Inverter

Symbol	Characteristic	Test Conditions	VALUE			Unit
			Min	Type	Max	
V_{CES}	Collector-Emitter voltage	$T_{vj}=25^{\circ}C$			1200	V
V_{GES}	Gate-Emitter voltage	$T_{vj}=25^{\circ}C$			± 20	V
I_C	Continuous DC collector current	Continuous@ $T_C=80^{\circ}C$			600	A
I_{CP}	Repetitive peak collector current	$T_P=1ms$			1200	A
P_{tot}	Total power dissipation	$T_j=175^{\circ}C$			2142	W
I_{CES}	Collector-emitter cut-off current	$T_{vj}=25^{\circ}C, V_{CE}=1200V, V_{GE}=0V$			0.1	mA
I_{GES}	Gate-emitter leakage current	$T_{vj}=25^{\circ}C, V_{CE}=0V, V_{GE}=\pm 20V$			± 0.2	μA
$V_{GE(th)}$	Gate threshold voltage	$T_{vj}=25^{\circ}C, V_{CE}=20V, I_C=24mA$	5.5	6.1	6.8	V
$V_{CE(sat)}$	Collector-emitter saturation voltage	$T_{vj}=25^{\circ}C, V_{GE}=15V, I_C=600A$		1.40	1.80	V
		$T_{vj}=125^{\circ}C, V_{GE}=15V, I_C=600A$		1.53		V
		$T_{vj}=150^{\circ}C, V_{GE}=15V, I_C=600A$		1.62		V
Q_G	Gate charge	$V_{GE}=\pm 15V$		5		μC
R_{Gint}	Internal gate resistor	$T_{vj}=25^{\circ}C$		2		Ω
C_{ies}	Input capacitance	$T_{vj}=25^{\circ}C, V_{CE}=25V, V_{GE}=0V, f=100kHz$		80		nF
C_{res}	Reverse transfer capacitance			1.48		nF
t_{don}	Turn-on Delay time, inductive load	$T_{vj}=150^{\circ}C, V_{CC}=600V, I_C=600A, V_{GE}=\pm 15V, R_g=1.5\Omega, \text{Inductive load}$		408		ns
t_r	Rise time, inductive load			132		ns
t_{doff}	Turn-off Delay time, inductive load			756		ns
t_f	Fall time, inductive load			404		ns
E_{on}	Turn-on energy loss per pulse	$I_C=600A, V_{CE}=600V, V_{GE}=\pm 15V, T_{vj}=150^{\circ}C, R_{Gon}=1.5\Omega$		53.0		mJ
E_{off}	Turn-off energy loss per pulse			96.7		mJ
I_{sc}	SC data	$V_{GE}\leq 15V, V_{CC}=800V, V_{CEmax}=V_{CES}-L_{sCE} \cdot di/dt, t_p\leq 10\mu s, T_{vj}=150^{\circ}C$		2600		A
$R_{th(j-c)}$	Thermal resistance, junction to case	per IGBT			0.07	$^{\circ}C/W$
$T_{vj op}$	Temperature under switching conditions	/	-40		150	$^{\circ}C$

2 Diode, Inverter

Symbol	Characteristic	Test Conditions	VALUE			Unit
			Min	Type	Max	
V_{RRM}	Repetitive peak reverse voltage	$T_{vj}=25^{\circ}\text{C}$			1200	V
I_F	Continuous DC forward current	/			600	A
I_{FRM}	Repetitive peak forward current	$T_P=1\text{ms}$			1200	A
V_F	Forward voltage	$T_{vj}=25^{\circ}\text{C}, I_F=600\text{A}$		1.30	2.00	V
		$T_{vj}=125^{\circ}\text{C}, I_F=600\text{A}$		1.72		V
		$T_{vj}=150^{\circ}\text{C}, I_F=600\text{A}$		1.75		V
I_{RM}	Peak reverse recovery current	$I_F=600\text{A}, -di_F/dt=5300\text{A}/\mu\text{s}, V_R=600\text{V}, V_{GE}=-15\text{V}, T_{vj}=150^{\circ}\text{C}$		700		A
Q_r	Recovered charge			138.9		μC
E_{rec}	Reverse recovery energy			54.9		mJ
$R_{th(j-c)}$	Thermal resistance, junction to case	per diode			0.13	$^{\circ}\text{C}/\text{W}$
$T_{vj\text{ op}}$	Temperature under switching conditions	/	-40		150	$^{\circ}\text{C}$

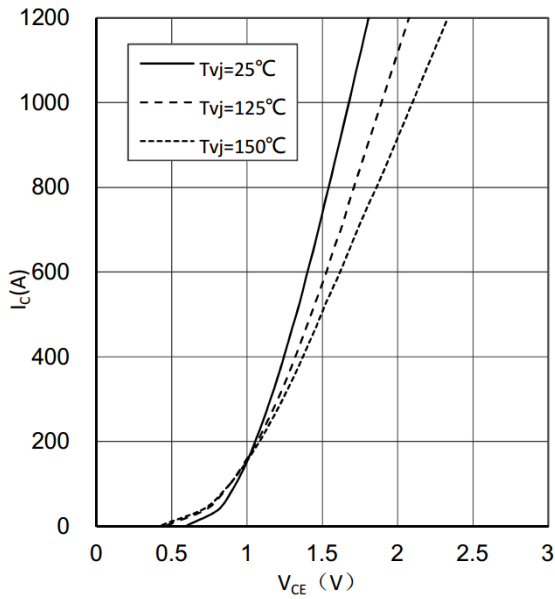
3 Package

Symbol	Characteristic	Test Conditions	VALUE			Unit
			Min	Type	Max	
V_{iso}	Isolation test voltage	$T_{vj}=25^{\circ}\text{C}, \text{AC}:1\text{minute}$	4000			V
T_{stg}	Storage temperature	/	-40		125	$^{\circ}\text{C}$
M	Mounting torque for module(M6)	/	3.0		6.0	N·m
	Terminal connection torque(M6)	/	2.5		5.0	N·m
W_t	Weight			320		g
Outline	M42a					

Output characteristic(typical)

$I_C = f(V_{CE})$

Fig-1

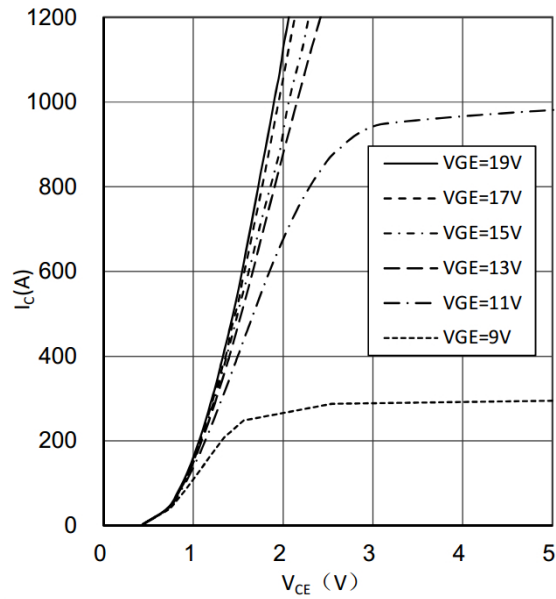


Output characteristic(typical)

$I_C = f(V_{CE})$

$T_{vj}=150^\circ\text{C}$

Fig-2

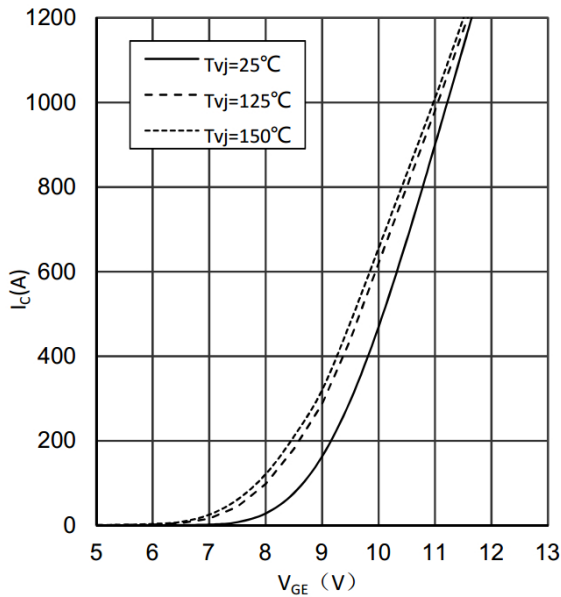


Transfer characteristic(typical)

$I_C = f(V_{GE})$

$V_{CE} = 20\text{V}$

Fig-3

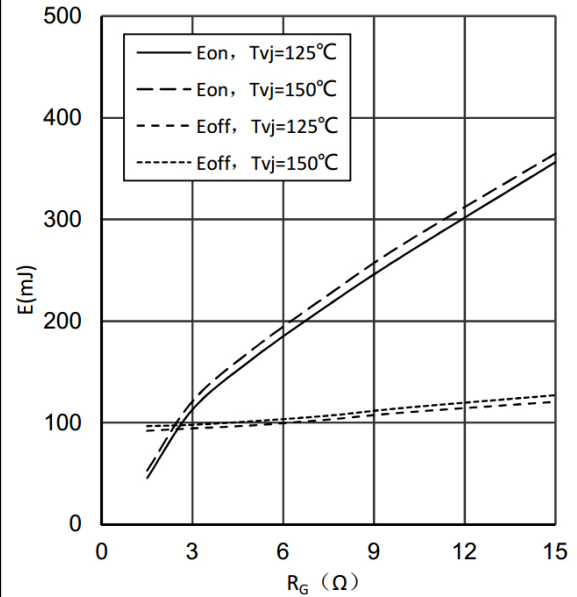


Switching losses IGBT (typical)

$E = f(R_G)$

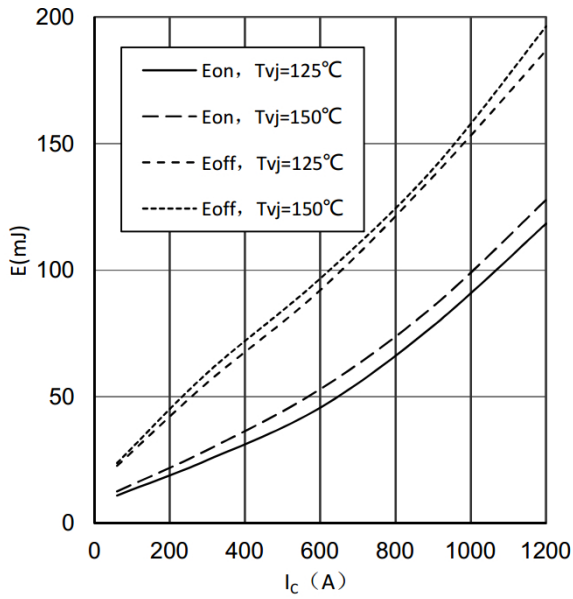
$V_{GE} = \pm 15\text{V}, I_C = 600\text{A}, V_{CE} = 600\text{V}$

Fig-4



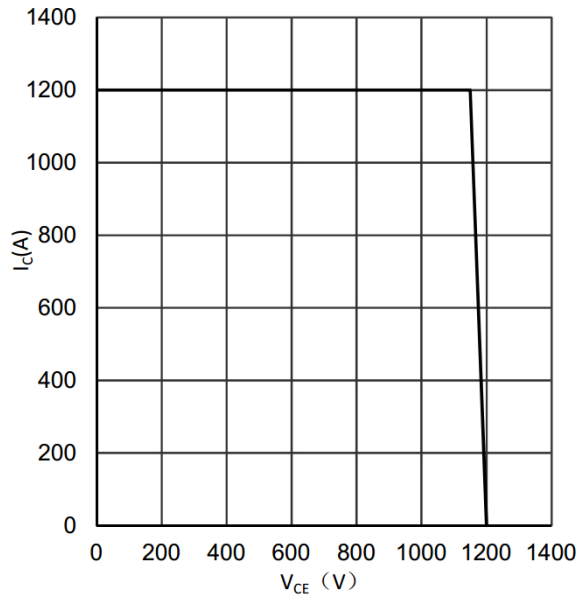
Switching losses IGBT (typical)

$E = f(I_C)$
 $V_{GE} = \pm 15V, R_G = 1.5\Omega, V_{CE} = 600V$
 Fig-5



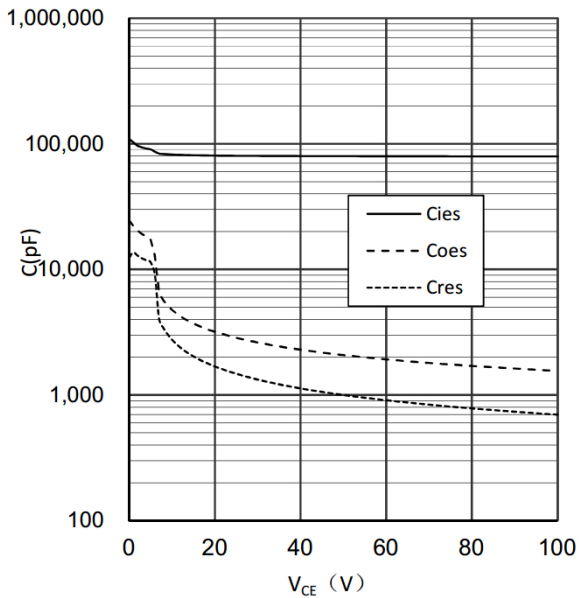
Reverse bias safe operating area(RBSOA)

$I_C = f(V_{CE})$
 $V_{GE} = \pm 15V, R_{goff} = 5.1\Omega, T_{vj} = 150^\circ C$
 Fig-6



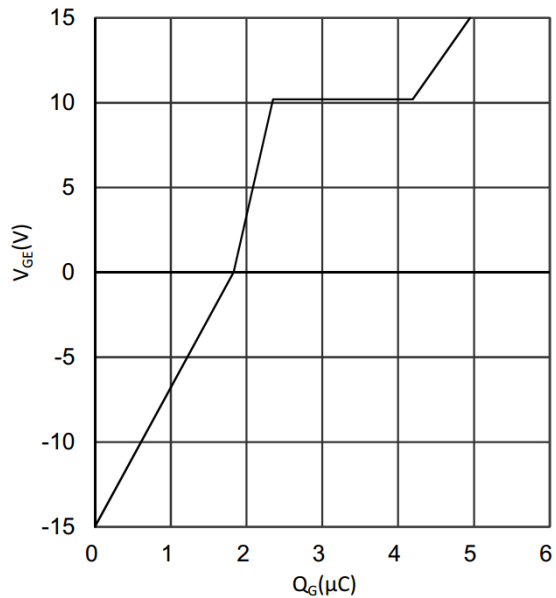
Typical capacitance as a function of collector-emitter voltage

$C = f(V_{CE})$
 $f = 100\text{ kHz}, V_{GE} = 0V$
 Fig-7



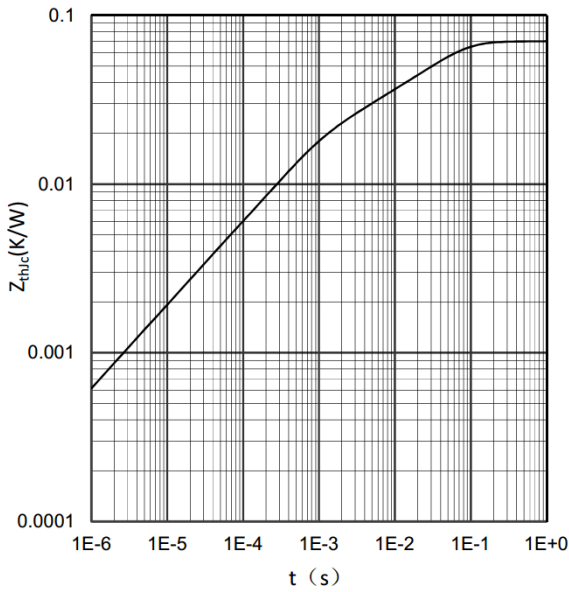
Gate charge (typical)

$V_{GE} = f(Q_G)$
 $I_C = 600A, V_{CE} = 600V$
 Fig-8



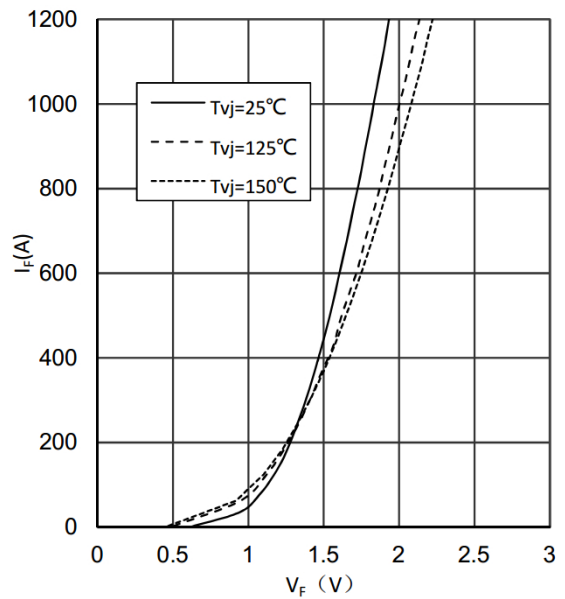
IGBT transient thermal impedance as a function of pulse width
 $Z_{th(j-c)} = f(t)$

Fig-9



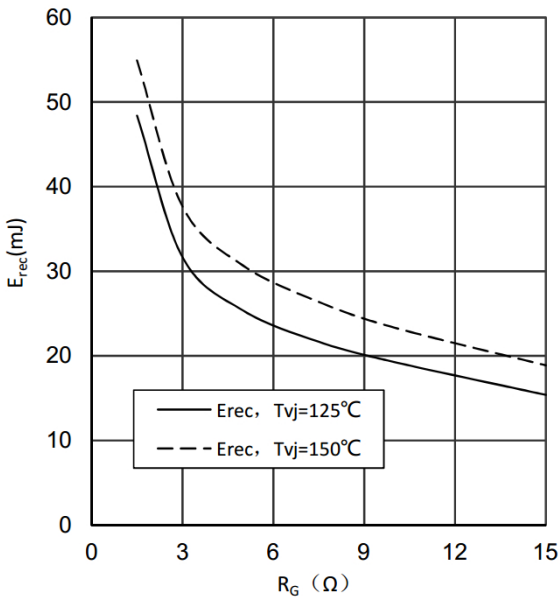
Forward characteristic of Diode (typical)
 $I_F = f(V_F)$

Fig-10



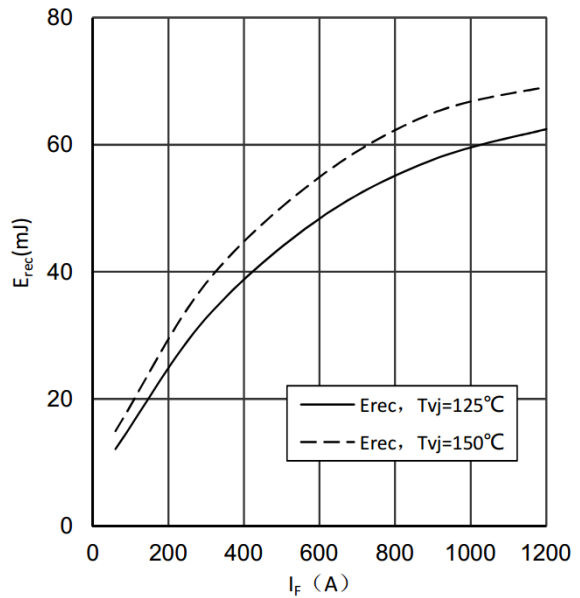
Switching losses Diode (typical)
 $E_{rec} = f(R_G)$

$I_F = 600A, V_{CE} = 600V$
 Fig-11



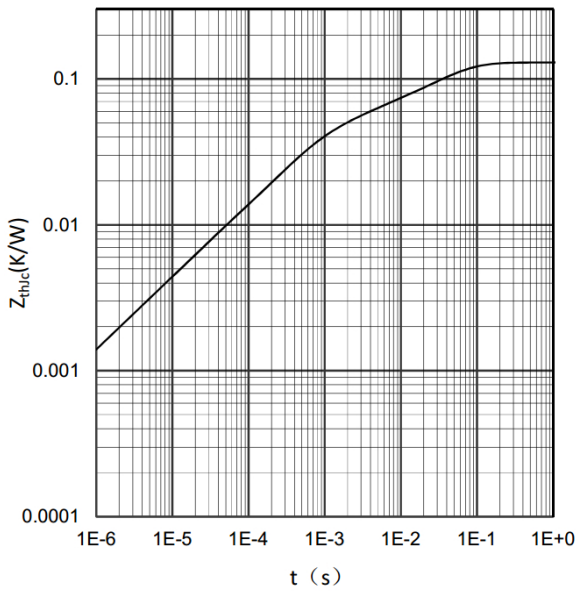
Switching losses Diode (typical)
 $E_{rec} = f(I_F)$

$R_G = 1.5Ω, V_{CE} = 600V$
 Fig-12

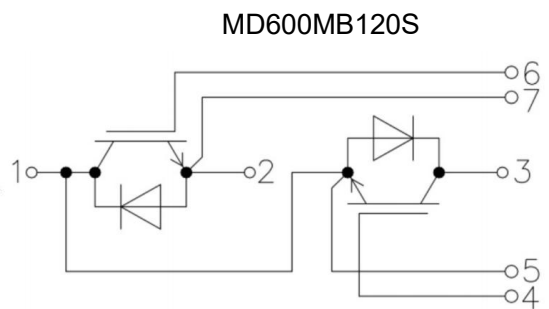
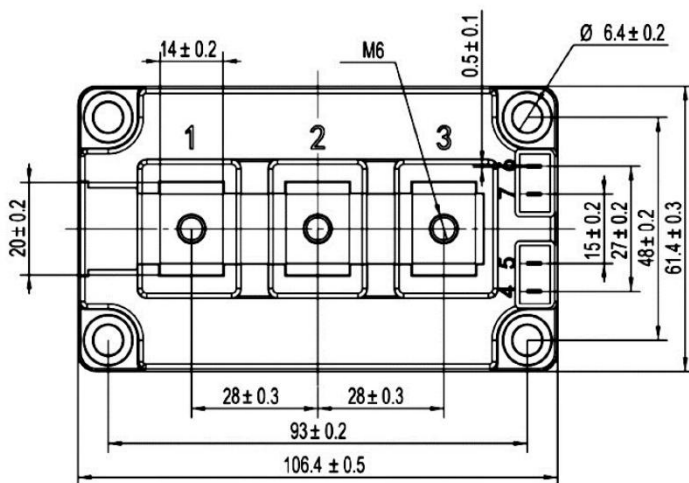
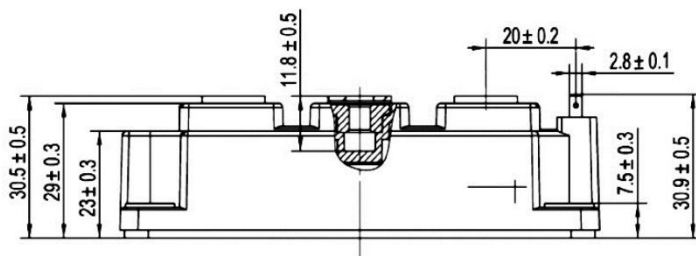


Diode transient thermal impedance as a function of pulse width
 $Z_{th(j-c)} = f(t)$

Fig-13



Package outlines & Circuit diagram



Unmarked dimensional tolerance: ±0.5mm

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